

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10813778			
<b>Filing Date:</b>	31-Mar-2004			
<b>Title of Invention:</b>	Method for manufacturing mounting substrate and method for manufacturing circuit device			
<b>First Named Inventor/Applicant Name:</b>	Kiyoshi Mita			
<b>Filer:</b>	Richard P. Ferrara/Frances Eng-Moy			
<b>Attorney Docket Number:</b>	14225-048001 / F1040146US			
Filed as Large Entity				
<b>Utility      Filing Fees</b>				
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
<b>Extension-of-Time:</b>				
Extension - 3 months with \$120 paid	1253	1	900	900

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	790	790
Total in USD (\$)				1690